Ordering number: EN1374E

CMOS IC

No.1374E

LC7533

3V Electronic Volume Control

Use

· Attenuation of signal

Features

· CMOS process 3V typ. operation
· Up/down operation is performed with SW input.
· 4-bit, 16-step counter. Step 6* is set with initial input ($\overline{INIT}$).
· Center tap provided.
· Maximum attenuation : −60dB or less
· Attenuation curve : Pseudo curve A. Left/right simultaneous setting.
* : Step 6 means mode 6.

Absolute Maximum Ratings at Ta = 25°C

			unit
Maximum Supply Voltage	V_{DD} max	V_{SS} to 6	V
Supply Voltage	V_I	V_{SS} to V_{DD}	V
Allowable Power Dissipation	Pd max	100	mW
Operating Temperature	**Topr**	−30 to +75	°C
Storage Temperature	Tstg	−40 to +125	°C

Allowable Operating Conditions at Ta = 25°C

				unit
Supply Voltage	V_{DD}		2.1 to 5.0	V
Input 'H'-Level Voltage	V_{IH1}	$\overline{INIT}$,CE pin	$0.7V_{DD}$ to V_{DD}	V
	V_{IH2}	$\overline{UP}$,$\overline{DN}$,CR pin	$0.9V_{DD}$ to V_{DD}	V
Input 'L'-Level Voltage	V_{IL1}	$\overline{INIT}$,CE	0 to $0.3V_{DD}$	V
	V_{IL2}	$\overline{UP}$,$\overline{DN}$,CR	V_{SS} to $0.1V_{DD}$	V

Electrical Characteristics at Ta = 25°C

			min	typ	max	unit
Signal Distortion	THD_1	V_{DD} = 3V, R_L = 50kΩ, f = 1kHz			0.5	%
	THD_2	V_{DD} = 2.1V, R_L = 50kΩ, f = 1kHz		1		%
Output at Attenuation Mode	X_{OUT}	0dBm input, 1kHz, 51kΩ load			−60	dB

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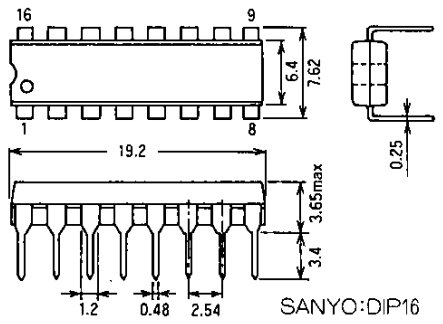
Package Dimensions 3006B-D16IC
(unit: mm)



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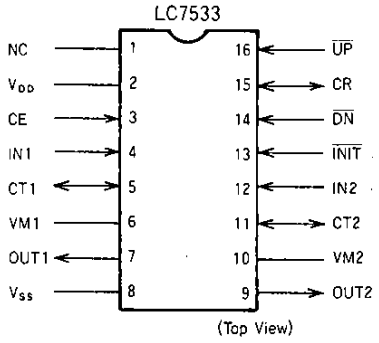
			min	typ	max	unit
Signal Transmit Delay Time	t_d	Between IN and OUT,no load		1		μs
Input Impedance	r_i	$\overline{UP}$,$\overline{DN}$,CE only	100		400	kΩ
Output Noise Voltage	V_{NO}	$V_{DD}=3V$,$R_L=50k\Omega$,STEP "0"			8	μV
Input 'H'-Level Current	I_{IH}	CE pin,$V_{DD}=3V$,$V_I=3V$			40	μA
Input 'L'-Level Current	I_{IL}	$\overline{UP}$,$\overline{DN}$ pin,$V_{DD}=3V$,$V_I=0V$	−55			μA
Attenuation Balance	ΔV	Pins OUT1,2,other than STEP "0" (Note 1)	−2	0	2	dB
Channel Balance	ΔV_O	Between pins OUT1,2,other than STEP "0" (Note 2)	−2		2	dB
Current Dissipation	I_{DD}	$V_{DD}=3V$,CE$=V_{DD}$,$\overline{INIT}=V_{DD}$, other pins : OPEN			1	mA
	I_{DD} BACK UP	$V_{DD}=3V$,CE$=V_{SS}$,$\overline{INIT}=V_{DD}$, other pins : OPEN			1	μA
Crosstalk between Channels	CT	$V_{DD}=1.5V$,$V_{SS}=-1.5V$,$V_M=0V$, f=1kΩ,1Vrms input, test side input : 1kΩ short		85		dB
Minimum Pulse Width	$T_{UP/DN}$	T=(CR oscillation cycle) $\overline{UP}$,$\overline{DN}$ pin		1.5_T		ms
	T_{INIT}	$\overline{INIT}$ pin	2			μs

Note 1 (1) $\Delta V=20\log 10\ V_{OUT}/V_{TYP}$
V_{OUT} : OUT1 (OUT2) output level
V_{TYP} : Standard output level
(2) Satisfy V_{OUT} (STEP N) < V_{OUT} (STEP N+1)

Note 2 (1) $\Delta V_O=20\log 10\ V_{OUT1}/V_{OUT2}$

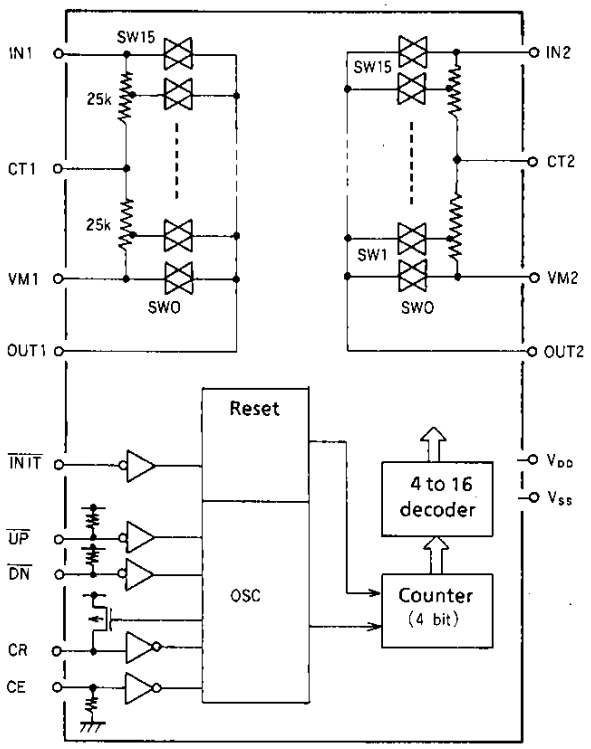
Pin Assignment



Note 1 : No bonding exists on the inside of NC pin. It is recommended that the outside should be shorted to V_{DD}, V_{SS}, etc. on the printed circuit board.

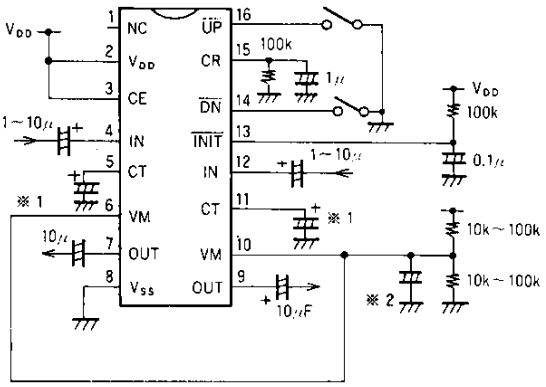
Equivalent Circuit Block Diagram

[Common to LC7533]



Note 1 : The TEST pin is bonded only when the MFP20 is used.

Sample Application Circuit [LC7533 DIP16]



For V_M, $1/2V_{DD}$ bias is recommended.

※1 For low-band boost (appro. 1μF)

※2 The larger the capacity is (appro. 100μF), the better the characteristics of attenuation and closstalk.

Unit (resistance: Ω, capacitance: F)

Pin Description

Pin Name	Pin Number	Description
IN1, IN2	4, 12	Input pin for volume control
OUT1, OUT2	7, 9	Output pin for volume control
V_{M1}, V_{M2}	6, 10	Bias pin. When operated form single supply, $1/2V_{DD}$ is applied to this pin.
C_{T1}, C_{T2}	5, 11	Tap pin provided at the center of volume control. By connecting C and R to this pin, the loudness can be controlled.
CE	3	When this pin is set to "L", the current dissipation is reduced. This pin must be "L" at backup mode.
$\overline{INIT}$	13	Initial pin. When set to "L", the 6th step is reached.
$\overline{UP}$	16	When the level on this pin is made to fall, the step rises and the volume goes up. When held at "L", the volume goes up; if set to "H", the volume stops going up at a step reached at that moment. The step stops at the MSB position.
$\overline{DN}$	14	The $\overline{DN}$ operation is the reverse of $\overline{UP}$. When the $\overline{UP}$, $\overline{DN}$ are set to "L" at the same time, the $\overline{UP}$ is given priority. The step stops at the LSB position.
CR	15	Pin for connecting R, C on which the rate of step depends.
V_{DD}	2	Power supply pin (+)
V_{SS}	8	Ground
NC	1	No bonding exists on the inside of NC pin. Connected to V_{DD} or V_{SS} is recommended.